



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Errol Todd Ryan

Serial No.: 09/706,043

Filed: November 3, 2000

For: Method for Forming Conductive
Interconnects

Group Art Unit: 1765

Examiner: Vanessa Perez Ramos

Atty. Dkt. No.: 2000.060900

1765 #6
MAR 3/14/03
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GROUP 1700

CERTIFICATE OF MAILING 37 C.F.R. 1.8	
I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on the date below:	
03/02/03 Date	Kathy Hlanas Signature

RESPONSE TO OFFICE ACTION DATED DECEMBER 19, 2002

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

This paper is submitted in response to the Office Action dated December 19, 2002 for which the shortened-statutory period for response is set to expire on March 19, 2003. Because this paper is being filed within the shortened statutory period for response, it is believed that no fees are due. Should, however, the Office require any extension of time and/or other fees deemed necessary for entry of this paper, please consider this paragraph such a request and authorization for the Assistant Commissioner to withdraw the appropriate fee under 37 C.F.R. §§ 1.16 to 1.21 from Advanced Micro Devices, Inc's Deposit Account No. 01-0365/TT4116.